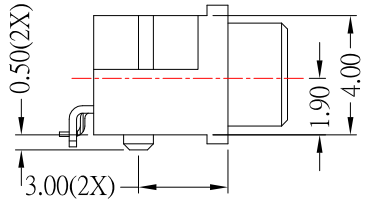
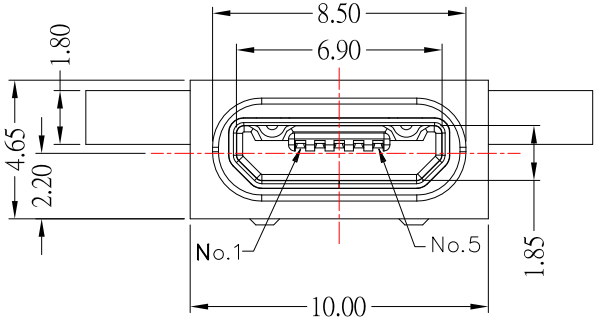
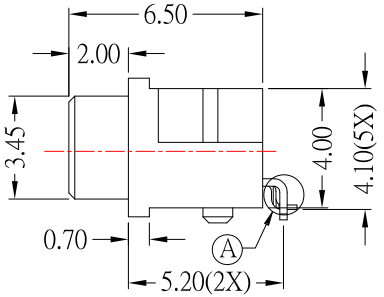
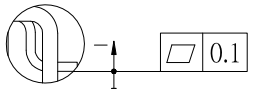
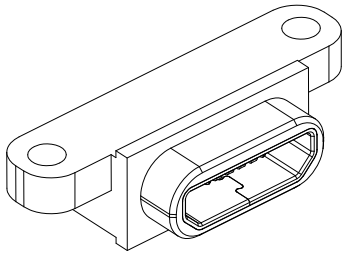


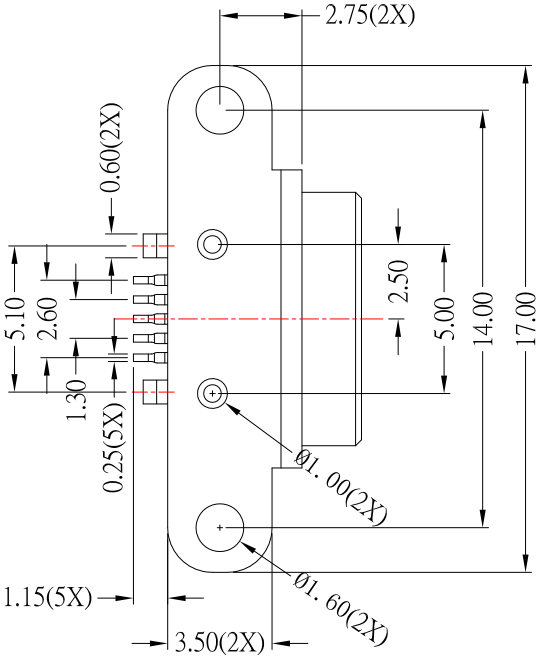


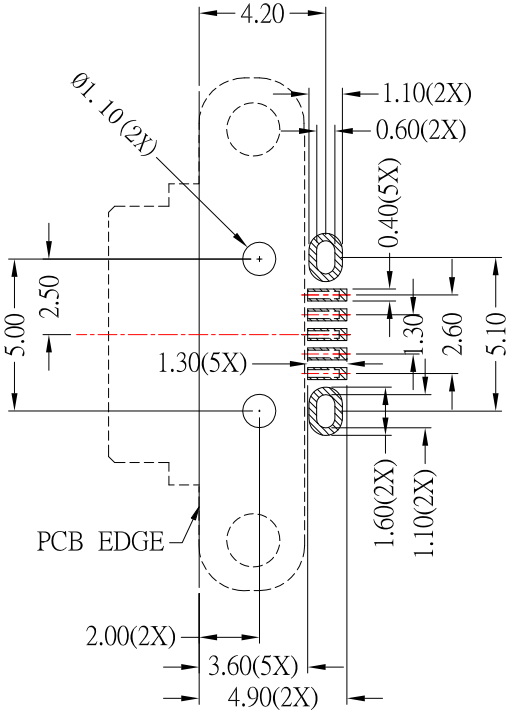






Waterproof Level : IPX 7





PCB LAYOUT MOUNTING PATTERN
TOP VIEW

Material:

1.Housing: PA10T

2.Contact: Phosphor Bronze

3.Shell: SUS

4.Cover: LCP

Finish:

1.Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls
Nickel under plated overall

2.Shell: Nickel under Plated surface layer

ITEM NO.	DESCRIPTION	DRAWN	DATE
5	更新材質	Jack	071317
4	新增Waterproof Level	Jack	031016
3	新增PCB LAYOUT的PIN長尺寸	Jack	102115
2	更新材質	Jack	072215
1	更新圖面	Jack	071615

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED : Up to 5 ±0.2; Above 5 ~ 15 ±0.3; Above 15 ~ 30 ±0.4; Above 30 ~ 50 ±0.5; Angle ±0.3°

3RD. ANGEL'S | UNITS MM

		DATE
DRAWN BY:	Jack Lu	07/13/17
CHECKED BY:	Jacky Chen	07/13/17
APPROVED BY:	Tony Kao	07/13/17

MAT'L		TITLE	CONNECTOR
FINISH		MODLE	MICRO USB 防水型
SCALE	1 : 1	DWG NO.	MRUSB-5B-WP1-S052
SHEET NO.	1 of 1	PART NO.	MRUSB-5B-WP1-S052

SIZE A4 | VER R5